ETR1119\_003

## Power MOSFET

## ■GENERAL DESCRIPTION

The XP151A13A0MR-G is an N-channel Power MOSFET with low on state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

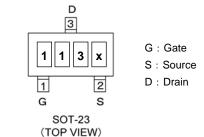
In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

## ■ APPLICATIONS

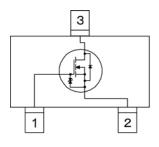
- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

### ■ PIN CONFIGURATION/ MARKING



\* x represents production lot number.

# ■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

## ■FEATURES

<b>Low On-State Resistance</b> : Rds(on) = $0.1 \Omega$ @ Vgs = $4.5V$
: Rds(on) = 0.14 Ω @ Vgs = 2.5V
: Rds(on) = 0.25 Ω @ Vgs = 1.5V
Ultra High-Speed Switching
Gate Protect Diode Built-in
Driving Voltage : 1.5V
N-Channel Power MOSFET
DMOS Structure
Small Package : SOT-23
Environmentally Friendly : EU RoHS Compliant, Pb Free

# ■PRODUCT NAMES

PRODUCTS	PACKAGE	ORDER UNIT
XP151A13A0MR	SOT-23	3,000/Reel
XP151A13A0MR-G <sup>(*)</sup>	SOT-23	3,000/Reel

<sup>(\*)</sup> The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

## ■ABSOLUTE MAXIMUM RATINGS

	Ta = 25°C						
PARAMETER	SYMBOL	RATINGS	UNITS				
Drain - Source Voltage	Vdss	20	V				
Gate - Source Voltage	Vgss	±8	V				
Drain Current (DC)	ld	1	А				
Drain Current (Pulse)	ldp	4	А				
Reverse Drain Current	ldr	1	А				
Channel Power Dissipation *	Pd	0.5	W				
Channel Temperature	Tch	150	°C				
Storage Temperature	Tstg	-55~150	°C				

\* When implemented on a ceramic PCB

# ■ELECTRICAL CHARACTERISTICS

### DC Characteristics

DC Characteristics Ta = 25°C						a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= 20V, Vgs= 0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs= $\pm$ 8V, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	0.5	-	1.2	V
Drain-Source On-State Resistance *1		ld= 0.5A, Vgs= 4.5V	-	0.075	0.100	Ω
	Rds(on)	ld= 0.5A, Vgs= 2.5V	-	0.10	0.14	Ω
		ld= 0.1A, Vgs= 1.5V	-	0.17	0.25	Ω
Forward Transfer Admittance *1	Yfs	ld= 0.5A, Vds= 10V	-	4.2	-	S
Body Drain Diode Forward Voltage	Vf	lf= 1A, Vgs= 0V	-	0.8	1.1	V

\*1 Effective during pulse test.

#### **Dynamic Characteristics**

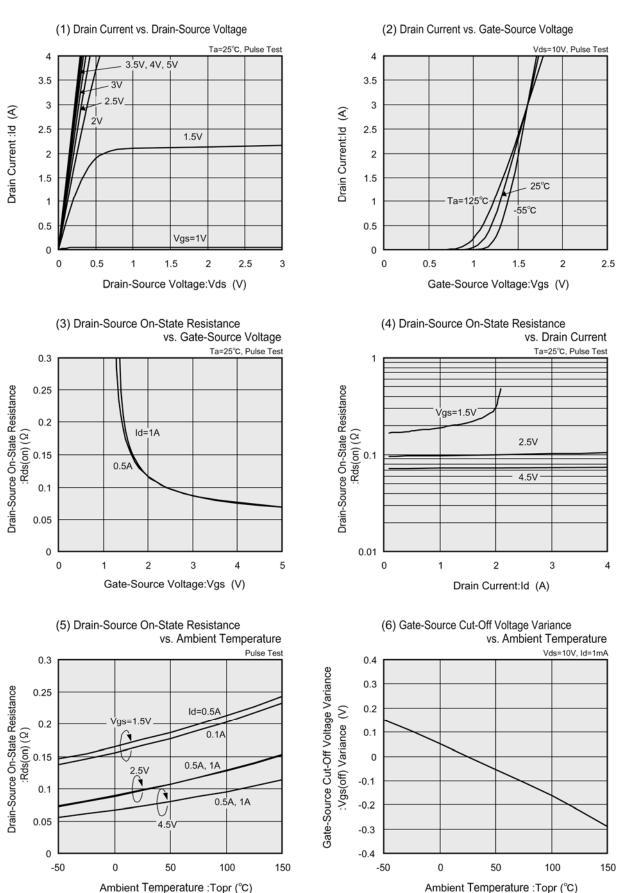
Dynamic Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	220	-	pF
Output Capacitance	Coss		-	120	-	pF
Feedback Capacitance	Crss		-	45	-	pF

#### **Switching Characteristics**

Switching Characteristics $T_a = 25^{\circ}C$						a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id= 0.5A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	75	-	ns
Fall Time	tf		-	65	-	ns

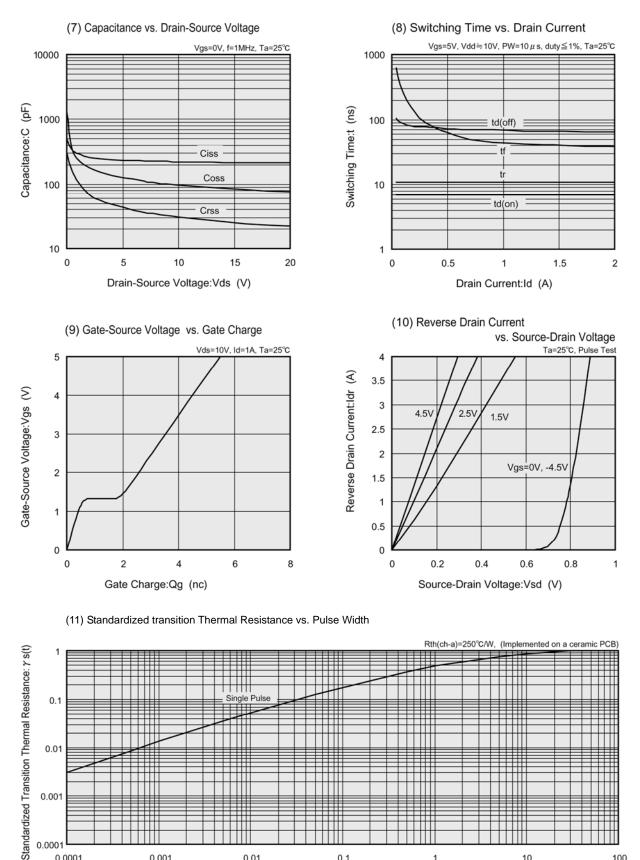
#### **Thermal Characteristics**

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W



## TYPICAL PERFOMANCE CHARACTERISTICS

# TYPICAL PERFOMANCE CHARACTERISTICS (Continued)



0.1

Pulse Width: PW (s)

1

10

100

4/5

0.001

0.0001

0.0001

0.001

0.01

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